Wolfspeed. A CREE COMPANY

E4D02120E



O CASE

Package Type: TO-252-2 Marking: E4D02120

4th Generation 1200 V, 2 A Silicon Carbide Schottky Diode

Description

With the performance advantages of a Silicon Carbide (SiC) Schottky Barrier diode, power electronics systems can expect to meet higher efficiency standards than Si-based solutions, while also reaching higher frequencies and power densities. SiC diodes can be easily paralleled to meet various application demands, without concern of thermal runaway. In combination with the reduced cooling requirements and improved thermal performance of SiC products, SiC diodes are able to provide lower overall system costs in a variety of diverse applications.

Features

- Low Forward Voltage (V_F) Drop with Positive **Temperature Coefficient**
- Zero Reverse Recovery Current / Forward **Recovery Voltage**
- Temperature-Independent Switching Behavior
- AEC-Q101 + HV-H3TRB Qualified, PPAP Capable

Applications

- Bootstrap Diode
- **Boost Diodes in PFC**
- Automotive Power Conversion

PIN 1O

PIN 2O

- **PV** Inverters
- **Outdoor Power Conversion**

Parameter	Symbol	Value	Unit	Test Conditions	Note
Repetitive Peak Reverse Voltage	V _{RRM}	1200	N/		
DC Blocking Voltage	V _{DC}	1200	V		
Continuous Forward Current		8	_	T _J = 25 °C	
	I _F	4		T _J = 135 °C	Fig. 3
		2	A	T _j = 160 °C	
Repetitive Peak Forward Surge	1	11	-	$T_c = 25 \text{ °C}, t_p = 10 \text{ ms}, \text{Half Sine Wave}$	
Current	FRM	7	-	$T_c = 110 \text{ °C}, t_p = 10 \text{ ms}, \text{Half Sine Wave}$	
Power Dissipation	P _{tot} –	50	- W	T _c = 25 °C	
		21		T _c = 110 °C	- Fig. 4

Maximum Ratings ($T_c = 25^{\circ}C$ unless otherwise specified)



Electrical Characteristics

Parameter	Symbol	Symbol Typ. Max. Units		Test Conditions	Note		
Forward Voltage	V	1.4	1.8	- V	I _F = 2 A, T _J = 25 °C	- Fig 1	
	V _F -	1.9			I _F = 2 A, T _J = 175 °C	- Fig. 1	
Reverse Current	1	10	50		$V_{R} = 1200 \text{ V}, \text{ T}_{J} = 25 \text{ °C}$	- Fig. 2	
	R	40		— μΑ	V _R = 1200 V, T _J = 175 °C		
Total Capacitive Charge	Q _c	16		nC	$V_{R} = 800 \text{ V}, \text{ T}_{J} = 25 \text{ °C}$	Fig. 5	
Total Capacitance		153			$V_{R} = 0 V, T_{J} = 25 °C, f = 1 MHz$		
	C	17		pF	V_{R} = 400 V, T_{J} = 25 °C, f = 1 MHz	- Fig. 6	
	-	14		_	$V_{R} = 800 \text{ V}, \text{ T}_{J} = 25 \text{ °C}, \text{ f} = 1 \text{ MHz}$	-	
Capacitance Stored Energy	E _c	5.6		μJ	V _R = 800 V	Fig. 7	

Note:

SiC Schottky Diodes are majority carrier devices, so there is no reverse recovery charge.

Thermal & Mechanical Characteristics

Parameter	Symbol	Value	Units	Note
Thermal Resistance, Junction to Case (Typ.)	$R_{_{ extsf{ heta},JC}}$	2.99	°C / W	
Operating Junction & Storage Temperature	T_{J},T_{stg}	-55 to +175	°C	Fig. 8
Maximum Processing Temperature	T _{PROC}	325	C	10 min. Maximum
Moisture Sensitivity Level	MSL	MSL 3		

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Value
Human Body Model	НВМ	Class 3B (≥ 8000 V)
Charge Device Model	CDM	Class C3 (≥ 1000 V)

Typical Performance

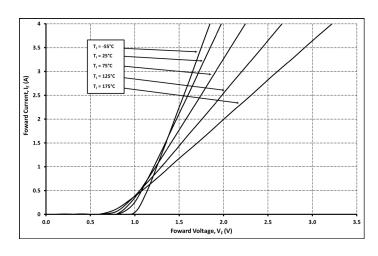


Figure 1. Forward Characteristics

Figure 2. Reverse Characteristics

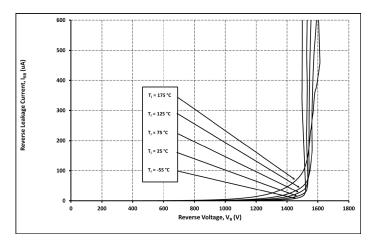
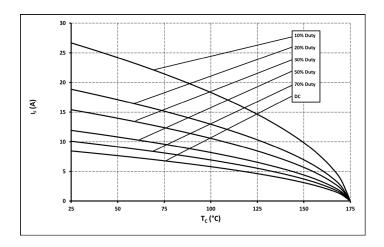


Figure 3. Current Derating





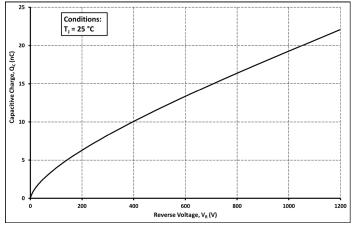


Figure 4. Power Derating

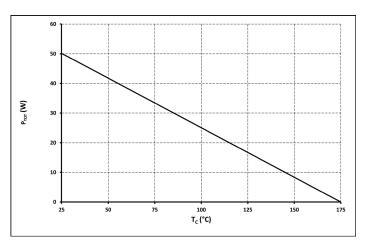
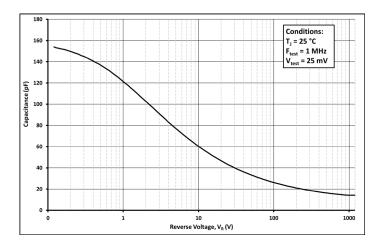


Figure 6. Capacitance vs. Reverse Voltage



Typical Performance

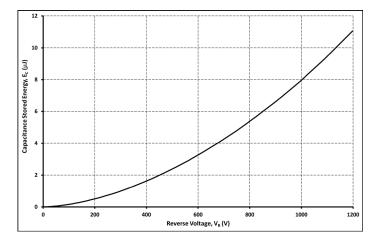
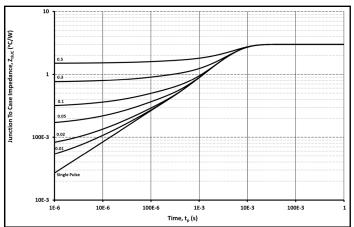


Figure 7. Capacitance Stored Energy

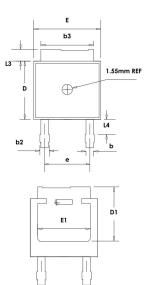


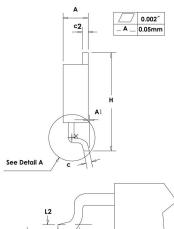




Package Dimensions

Package: TO-252-2 All dimensions in mm.



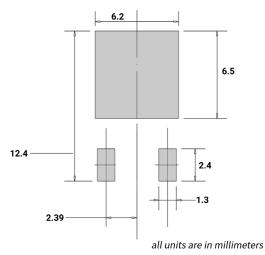


0.004″ 0.1mm

0 -5

	MILLIMETERS				
SYMBOL	MIN	MAX			
A	2.159	2.413			
A1	0	0.13			
b	0.64	0.89			
b2	0.653	1.143			
b3	5.004	5.6			
с	0.457	0.61			
c2	0.457	0.864			
D	5.867	6.248			
D1	5.21	-			
E	6.35	7.341			
E1	4.32	-			
e	4.58 BSC				
Н	9.65	10.414			
L	1.106	1.78			
L2	0.51 BSC				
L3	0.889	1.27			
L4	0.64	1.01			
θ	0°	8°			

Recommended Solder Pad Layout



Learn more about recommended soldering profiles in this application note.



E4D02120E



Notes

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